STATUS REQUEST					Docket Number CT00-020	
	In re Application of FU, CHIA-YU					
	Application Number	09/712749	File Date	11-14-2000		
	Title	LOW PROFILE INTEGRATED MODULE INTERCONNECTS AND METHOD OF FABRICATION				
	Group Art Unit	3729	Examiner	IRVIN DINGLE		
The last paper(s) received by Applicant(s) was: Official Filing Receipt X Other Notice of Dismissed Petition mailed on December 3, 2007.						
The last paper(s) submitted by Applicant(s) was: X Renewed Petition to Revive submitted on January 24, 2008. Since the transmittal/receipt of said paper(s), no other communications have been received from the United States Patent and Trademark Office.						
Pi	torney or Agent inted Name gnature	Attorney DOLEZAL, DAVID.G.		_Registration Number	41,711	
1	ate	April 24, 2008				
CERTIFICATE OF MAILING, TRANSMISSION OR EFS FILING I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as first-class mail in an envelope addressed to the Commissioner for Patents, Alexandria, VA 22313-1450; or facsimile transmitted to the U.S.P.T.O.; or electronically filed on the date below.						
Name Dee Matocha						
	Signature Date April 24, 2008					

.